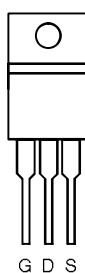


**SUP/SUB75N05-06A***New Product***Vishay Siliconix****N-Channel 50-V (D-S), 175°C MOSFET****PRODUCT SUMMARY**

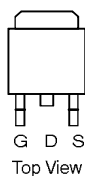
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)
50	0.006	75

TO-220AB

Top View

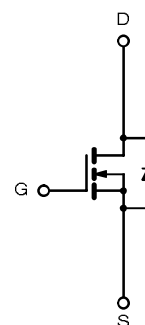
Ordering Information: SUP75N05-06A

DRAIN connected to TAB

TO-263

Top View

Ordering Information: SUB75N05-06A



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ($T_J = 175^\circ\text{C}$)	$T_C = 25^\circ\text{C}$	I_D	75 ^a	A
	$T_C = 125^\circ\text{C}$		70	
Pulsed Drain Current		I_{DM}	240	
Avalanche Current		I_{AR}	75	
Repetitive Avalanche Energy ^b		E_{AR}	280	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$ (TO-220AB and TO-263)	P_D	250 ^c	W
	$T_A = 25^\circ\text{C}$ (TO-263) ^d		3.7	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R_{thJA}	40	$^\circ\text{C/W}$
	Free Air (TO-220AB)		62.5	
Junction-to-Case		R_{thJC}	0.6	

Notes

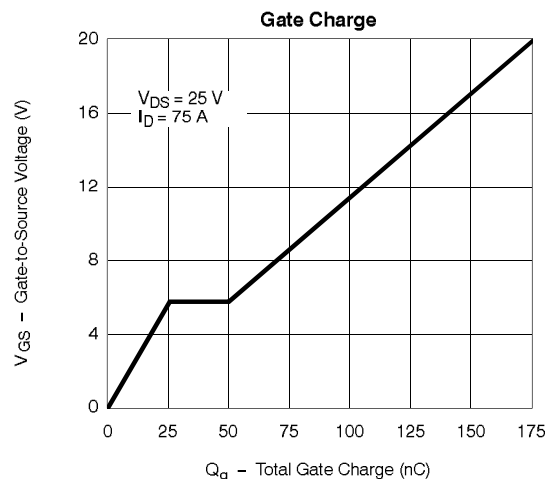
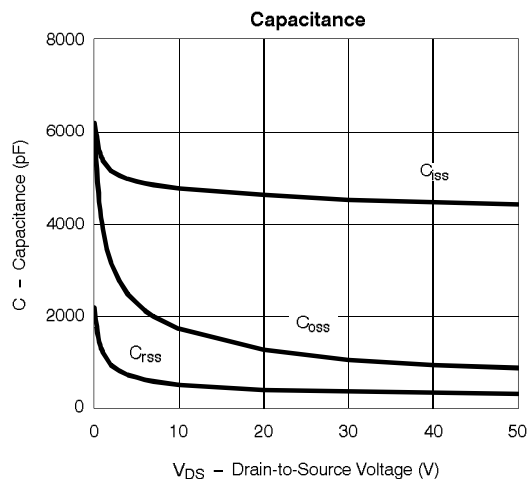
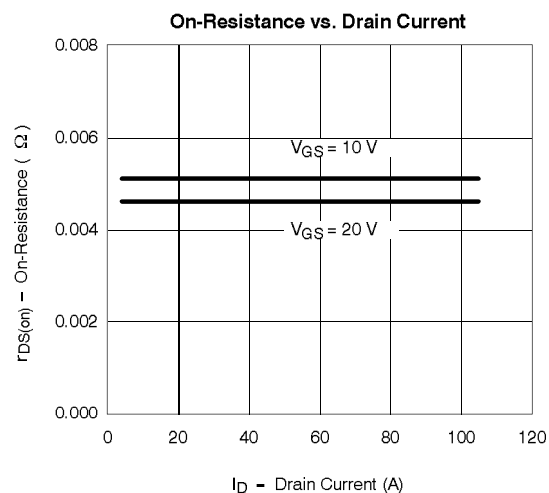
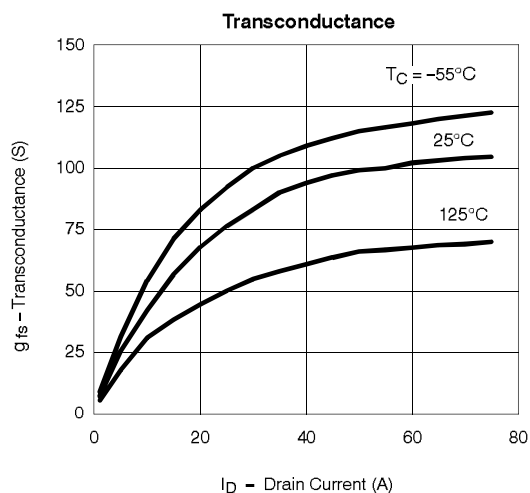
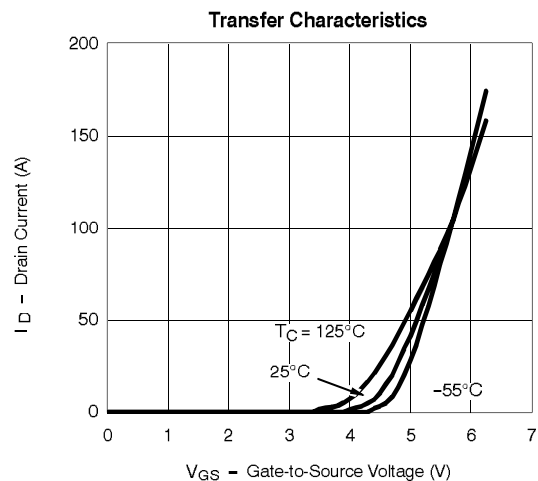
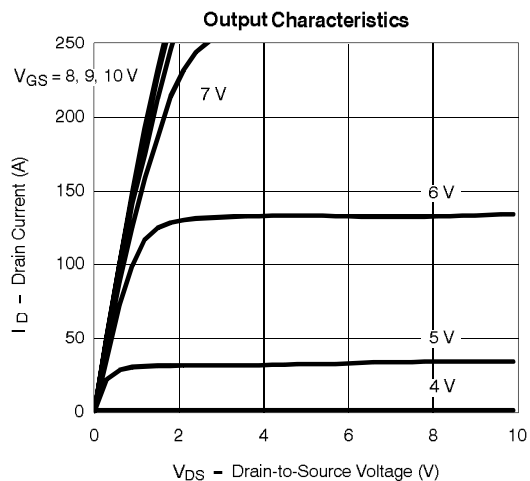
- a. Package limited.
- b. Duty cycle $\leq 1\%$.
- c. See SOA curve for voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

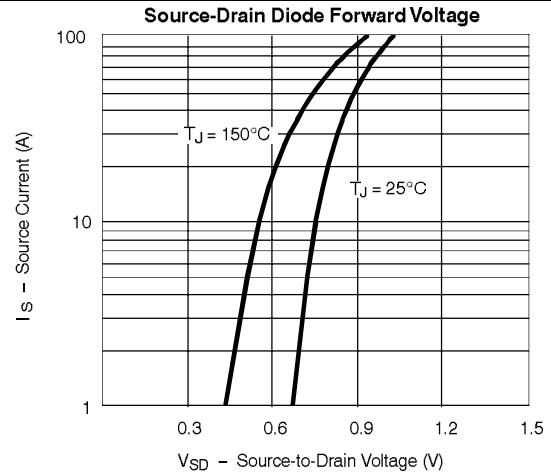
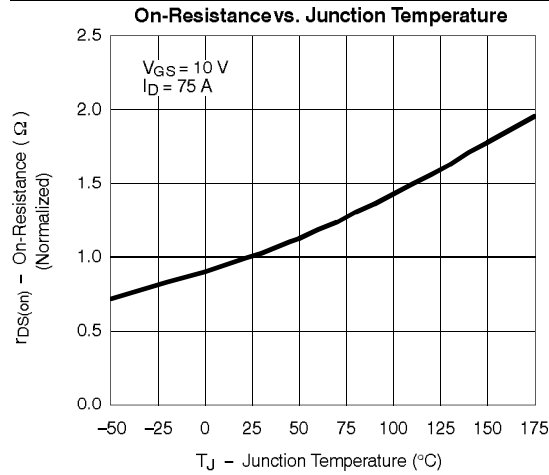


SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA	50			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2.0		4.0	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 50 V, V _{GS} = 0 V			1	μA
		V _{DS} = 50 V, V _{GS} = 0 V, T _J = 125°C			50	
		V _{DS} = 50 V, V _{GS} = 0 V, T _J = 175°C			150	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	120			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 75 A		0.005	0.006	Ω
		V _{GS} = 10 V, I _D = 75 A, T _J = 125°C			0.010	
		V _{GS} = 10 V, I _D = 75 A, T _J = 175°C			0.012	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 60 A	30			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		4500		pF
Output Capacitance	C _{oss}			1100		
Reverse Transfer Capacitance	C _{rss}			360		
Total Gate Charge ^c	Q _g	V _{DS} = 25 V, V _{GS} = 10 V, I _D = 75 A		85	120	nC
Gate-Source Charge ^c	Q _{gs}			25		
Gate-Drain Charge ^c	Q _{gd}			25		
Gate Resistance	R _g	f = 1.0 MHz		3		Ω
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 25 V, R _L = 0.33 Ω I _D ≅ 75 A, V _{GEN} = 10 V, R _g = 2.5 Ω		20	40	ns
Rise Time ^c	t _r			20	100	
Turn-Off Delay Time ^c	t _{d(off)}			50	100	
Fall Time ^c	t _f			20	40	
Source-Drain Diode Ratings and Characteristics (T _C = 25°C) ^b						
Continuous Current	I _S				75	A
Pulsed Current	I _{SM}				200	
Forward Voltage ^a	V _{SD}	I _F = 75 A , V _{GS} = 0 V		1.0	1.4	V
Reverse Recovery Time	t _{rr}	I _F = 75 A, di/dt = 100 A/μs		65	120	ns
Peak Reverse Recovery Current	I _{RM(REC)}			5	8	A
Reverse Recovery Charge	Q _{rr}			0.16	0.48	μC

Notes

- a. Pulse test: pulse width $\leq 300\text{ }\mu\text{sec}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)****THERMAL RATINGS**